

# PATENT ASSIGNMENT

Electronic Version v1.1  
 Stylesheet Version v1.1

<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
Masao Nishizawa	05/06/2011
Kenji Kida	05/06/2011
Fumihito Ishida	05/06/2011
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	APIC YAMADA CORPORATION
<b>Street Address:</b>	90 Kamitokuma, Chikuma-shi
<b>City:</b>	Nagano-ken
<b>State/Country:</b>	JAPAN
<b>Postal Code:</b>	389-0898
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
<b>Application Number:</b>	13117995
<b>CORRESPONDENCE DATA</b>	
<b>Fax Number:</b>	(646)710-1129
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>	
<b>Phone:</b>	212-408-1129
<b>Email:</b>	patents@chadbourne.com
<b>Correspondent Name:</b>	Chadbourne & Parke LLP
<b>Address Line 1:</b>	30 Rockefeller Plaza
<b>Address Line 4:</b>	New York, NEW YORK 10112
<b>ATTORNEY DOCKET NUMBER:</b>	21183-002US
<b>NAME OF SUBMITTER:</b>	Walter G. Hanchuk
<b>Total Attachments: 3</b> source=21183-002USAssignment#page1.tif source=21183-002USAssignment#page2.tif source=21183-002USAssignment#page3.tif	

CH \$40.00 13117995

501550562

**PATENT**  
**REEL: 026370 FRAME: 0807**

ASSIGNMENT OF APPLICATION FOR PATENT

WHEREAS:

**MASAO NISHIZAWA, Chikuma-shi, Nagano-ken, Japan,**

**KENJI KIDA, Chikuma-shi, Nagano-ken, Japan,**

**FUMIHITO ISHIDA, Chikuma-shi, Nagano-ken, Japan,**

(hereinafter referred to as ASSIGNOR(S)), have made a discovery or invention entitled:

**RFID TAG, WIRELESS CHARGING ANTENNA PART, METHOD OF  
MANUFACTURING THE SAME, AND MOLD**

- ☒ for which application for Letters Patent of the United States has been executed on even date herewith,
- ☐ for which application for Letters Patent of \_\_\_\_\_ has been filed on \_\_\_\_\_, under Serial No. \_\_\_\_\_, and
- ☐ for which application for Letters Patent of the United States has been filed on \_\_\_\_\_, under Serial No. \_\_\_\_\_,

and

WHEREAS:

**APIC YAMADA CORPORATION**

**90 Kamitokuma, Chikuma-shi, Nagano-ken, Japan**

(hereinafter referred to as "ASSIGNEE") is desirous of acquiring the entire interest in, to and under said invention and in, to and under Letters Patent or similar legal protection to be obtained therefore in the United States and in any and all other countries

NOW THEREFORE, TO ALL IT MAY CONCERN:

Be it known that for valuable consideration from ASSIGNEE to ASSIGNOR(S) the receipt of which is hereby acknowledged I, said ASSIGNOR(S) hereby sell, assign and transfer to ASSIGNEE and its successors, other legal representatives and assigns the entire

right, title and interest to said discovery or invention in the United States and its territorial possessions and in all other countries and to all Letters Patent or similar legal protection in the United States and its territorial possessions and in any and all other countries to be obtained for said invention by said application or any continuation, continuation in part, division, renewal, substitute, reissue or reexamination thereof or any legal equivalent thereof in any other country for the full term or terms for which the same may be granted.

I, said ASSIGNOR(S), hereby covenant that I (we) have the full right to convey the entire interest herein assigned and that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment;

I, said ASSIGNOR(S), hereby agree to execute all papers necessary in connection with the application and any continuation, continuation in part, divisional, reissue, reexamination or corresponding applications thereof and also to execute separate assignments in connection with such applications as the ASSIGNEE may deem necessary or expedient;

I, said ASSIGNOR(S), hereby authorize and request the Commissioner of Patents and Trademarks of the United States and the empowered officials of all other governments to issue all said Letters Patent for said discovery or invention to the ASSIGNEE as assignee of the entire right, title and interest into and under the same, for the sole use and enjoyment of said ASSIGNEE, its successors and assigns;

I, said ASSIGNOR(S), hereby authorize the ASSIGNEE to apply for and obtain the recordation of this Assignment. I, said ASSIGNOR(S), also hereby agree that I (we) shall, without further consideration, promptly and duly cause to be performed such lawful acts and execution of any other documents as the ASSIGNEE may reasonably request in order for the ASSIGNEE to obtain the full benefit of this Assignment and to permit the Assignment to be duly recorded in each office, bureau and tribunal in the appropriate jurisdiction as the registered owner or proprietor of each of the rights hereby assigned. Such instruments and documents shall include, without limitation, affidavits, including affidavits of use, and other documents for filing in such jurisdictions as the ASSIGNEE may from time to time reasonably request.

AND it is further covenanted and agreed that I, said ASSIGNOR(S), will, at any time upon request by the ASSIGNEE, its successors, legal representatives or assigns, communicate to said ASSIGNEE, its successors, assigns or other legal representatives, any facts relating to said invention(s) and the history thereof known to said ASSIGNOR(S) and testify as to same in any interference or any other legal proceeding when requested to do so, sign any and all lawful papers, execute any and all necessary assignment papers to cause any Letters Patent to be issued to ASSIGNEE, make all rightful oaths and generally do everything necessary or desirable to aid said ASSIGNEE, its successors and assigns, to obtain, perfect title in and enforce proper protection for said inventions in the United States and in any and all other countries, all without further compensation but at the expense of the ASSIGNEE, its successors, legal representatives and assigns.

SIGNED:

1. MASAO NISHIZAWA

MASAO NISHIZAWA

May. 06. 2011

Date

2. K. Kida

KENJI KIDA

May. 06. 2011

Date

3. F. Ishida

FUMIITO ISHIDA

May. 06. 2011

Date